PRODUCT FAMILY DATA SHEET

Cree[®] XLamp[®] XP-C LEDs



PRODUCT DESCRIPTION

The XLamp® XP-C LED combines the proven lighting-class performance and reliability of the XLamp XR-E LED in a package with 80% smaller footprint. The XLamp XP-C LED continues Cree's history of innovation in LEDs for lighting applications with wide viewing angle, symmetrical package, unlimited floor life and electrically neutral thermal path.

Cree XLamp LEDs bring high performance and quality of light to a wide range of lighting applications, ncluding color-changing lighting, portable and personal lighting, outdoor lighting, indoor directional lighting, commercial lighting and emergency-vehicle lighting.

FEATURES

- Available in white (2600 K to 10,000 K CCT), royal blue, blue, green, amber, red-orange, red
- Maximum drive current: up to 500 mA
- Low thermal resistance: as low as 10 °C/W
- Wide viewing angle: 110° 125°
- Unlimited floor life at ≤ 30 °C/85% RH
- Reflow solderable JEDEC J-STD-020C compatible
- Electrically neutral thermal path
- RoHS- and REACh-compliant
- UL-recognized component (E349212)



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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white, royal blue, blue	°C/W		12	
Thermal resistance, junction to solder point - green	°C/W		20	
Thermal resistance, junction to solder point - amber	°C/W		15	
Thermal resistance, junction to solder point - red, red-orange	°C/W		10	
Viewing angle (FWHM) - white	degrees		115	
Viewing angle (FWHM) - royal blue, blue, green, red, red-orange, amber	degrees		125	
Temperature coefficient of voltage - white, blue, royal blue, green	mV/°C		-4.0	
Temperature coefficient of voltage - amber, red-orange, red	mV/°C		-2.0	
ESD withstand voltage (HBM per Mil-Std-883D) - white, royal blue, blue, green	V			8000
ESD Classification (HBM per Mil-Std-883D) - amber, red-orange, red			Class 2	
DC forward current - white, royal blue, blue, green	mA			500
DC forward current - amber, red-orange, red	mA			350
Reverse voltage	V			5
Forward voltage (@ 350 mA) - white	V		3.2	3.9
Forward voltage (@ 350 mA) - royal blue, blue	V		3.3	3.9
Forward voltage (@ 350 mA) - green	V		3.4	3.9
Forward voltage (@ 350 mA) - amber, red-orange, red	V		2.2	2.5
Forward voltage (@ 125 mA) - royal blue, blue	V		3.1	
Forward voltage (@ 125 mA) - green	V		3.3	
Forward voltage (@ 125 mA) - red-orange, red	V		2.0	
Forward voltage (@ 125 mA) - amber	V		2.1	
Forward voltage (@ 500 mA) - royal blue, blue, white	V		3.5	
Forward voltage (@ 500 mA) - green	V		3.6	
LED junction temperature	°C			150



FLUX CHARACTERISTICS (T₁ = 25 °C)

The following table provides several base order codes for XLamp XP-C LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP LED Family Binning and Labeling document.

Color	ССТ Р	Range	Min Lumi	ler Codes nous Flux i0 mA	Order Code
	Min.	Max.	Group	Flux (lm)	
			Q2	87.4	XPCWHT-L1-0000-00A01
Cool White	5000 K	10,000 K	Q3	93.9	XPCWHT-L1-0000-00B01
			Q4	100	XPCWHT-L1-0000-00C01
	3700 K		Р3	73.9	XPCWHT-L1-0000-008E4
Neutral White		5300 K	P4	80.6	XPCWHT-L1-0000-009E4
			Q2	87.4	XPCWHT-L1-0000-00AE4
			N4	62.0	XPCWHT-L1-0000-006E7
Warm White	2600 K	3700 K	P2	67.2	XPCWHT-L1-0000-007E7
			Р3	73.9	XPCWHT-L1-0000-008E7

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements.
- Typical CRI for Cool White (5000 K 10,000 K CCT) is 70.
- Typical CRI for Neutral White (3700 K 5300 K CCT) is 75.
- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.

FLUX CHARACTERISTICS (T₁ = 25 °C) - COLOR

The following table provides several base order codes for XLamp XP-C LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP LED Family Binning and Labeling document.

	Domi	nant Wav	elength F	lange	Base Order Codes Min. Radiant				
Color	Mi	in.	Max.		Flux @ 350 mA		Calculated Min. Radiant Flux (mW) @ 125 mA*	Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)			
				95 465	12	250	104	XPCROY-L1-0000-00701	
Royal Blue	D3	450	D5		13	300	124	XPCROY-L1-0000-00801	
				14	350	145	XPCROY-L1-0000-00901		

* Calculated values for reference only

CREE

XLAMP[®] XP-C LEDS

	Domi	nant Wav	elength F	Range	Base Order	Codes Min.			
Color	Mi	n.	Max.		Luminous Flu	ux @ 350 mA	Calculated Min. Luminous Flux (lm) @ 125 mA*	Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)			
Blue	82	B3 465 B6	DC	485	J	23.5	10.8	XPCBLU-L1-0000-00W01	
Blue	B3		465	во	405	K2	30.6	13.8	XPCBLU-L1-0000-00Y01

	Domi	nant Wav	elength F	Range	Base Order Codes Min.													
Color	Mi	in. Max. Luminous Flux @ 350 mA		Calculated Min. Luminous Flux (lm) @ 125 mA*	Order Code													
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)												
			G4		N3	56.8	28.2	XPCGRN-L1-0000-00501										
	63	520				~ .		64	64	64	64	64	64	535	N4	62	30.8	XPCGRN-L1-0000-00601
Green	reen G2 520	520 G4		G4 535	P2	67.2	33.3	XPCGRN-L1-0000-00701										
				P3	73.9	36.7	XPCGRN-L1-0000-00801											

	Domi	nant Wav	velength F	Range	Base Order	Codes Min.							
Color	Mi	n.	Max.		Max.		Luminous Flux @ 350 mA		Calculated Min. Luminous Flux (lm) @ 125 mA*	Order Code			
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	Flux (Im) @ 125 mA*						
			4.2		M2	39.8	14.9	XPCAMB-L1-0000-00201					
Amber	A2	585		4.2	4.2	47	12	42	A3	595	M3	45.7	17.1
Amber	mber Az 585	585 A3	A3 595	N2	51.7	19.4	XPCAMB-L1-0000-00401						
				N3	56.8	21.3	XPCAMB-L1-0000-00501						

	Domi	Dominant Wavelength			Base Order Codes Min.								
Color	Mi	in.	Max.		Luminous Flux @ 350 mA		Calculated Min. Luminous Flux (lm) @ 125 mA*	Order Code					
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	Flux (Im) @ 125 mA*						
					N2	51.7	19.8	XPCRDO-L1-0000-00401					
Red-	03	(10		04	04	04	04	04	4 (20)	N3	56.8	21.7	XPCRDO-L1-0000-00501
Orange	Drange O3 610	610 04	010			620	N4	62	23.7	XPCRDO-L1-0000-00601			
				P2	67.2	25.7	XPCRDO-L1-0000-00701						

* Calculated values for reference only

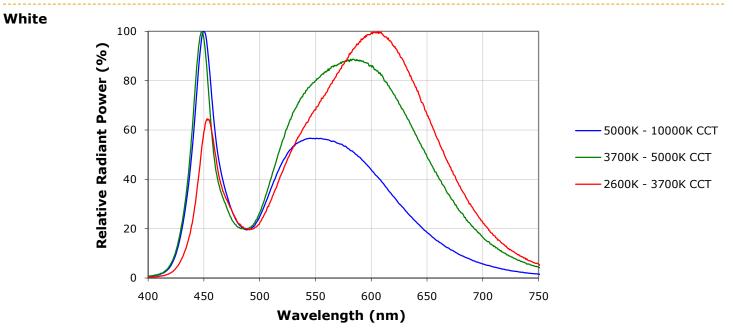
	Domi	nant Wav	elength F	Range	Base Order Codes Min.							
Color	Mi	n.	Max.		Luminous Flux @ 350 mA		Calculated Min. Luminous Flux (lm) @ 125 ma*	Order Code				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)						
			D2	D 2		M2	39.8	15.2	XPCRED-L1-0000-00201			
Red	R2	620			02	D 3	63	D3	R3	R3 630	M3	45.7
Reu	J KZ 620	RZ 620 R3 630	030	N2	51.7	19.7	XPCRED-L1-0000-00401					
				N3	56.8	21.7	XPCRED-L1-0000-00501					

* Calculated values for reference only

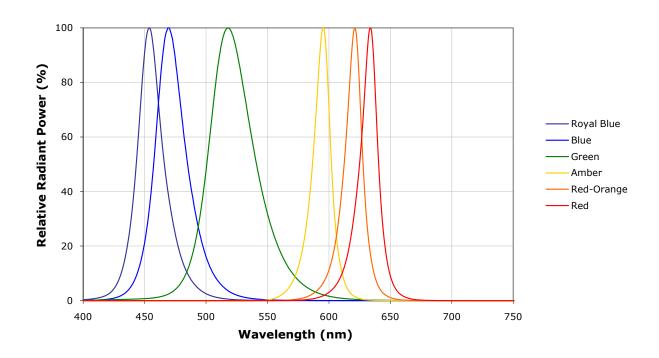
Note: Cree maintains a tolerance of \pm 7% on flux and power measurements and \pm 1 nm on dominant wavelength measurements.



RELATIVE SPECTRAL POWER DISTRIBUTION

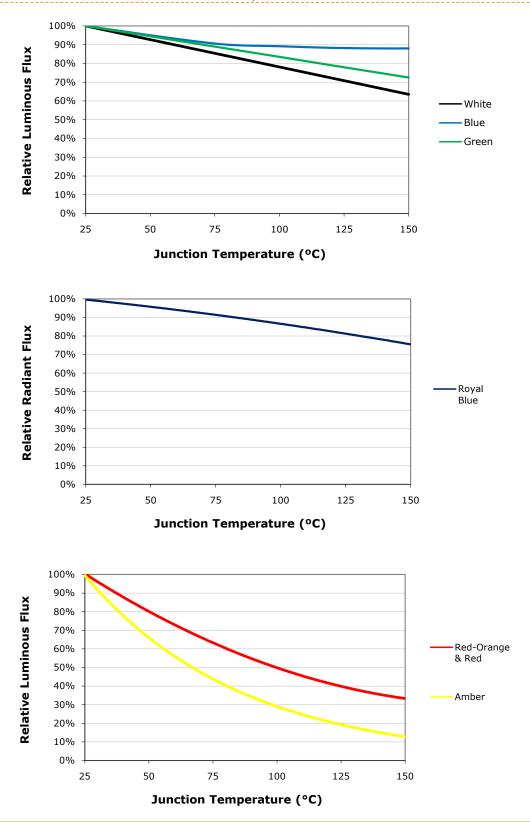


Color





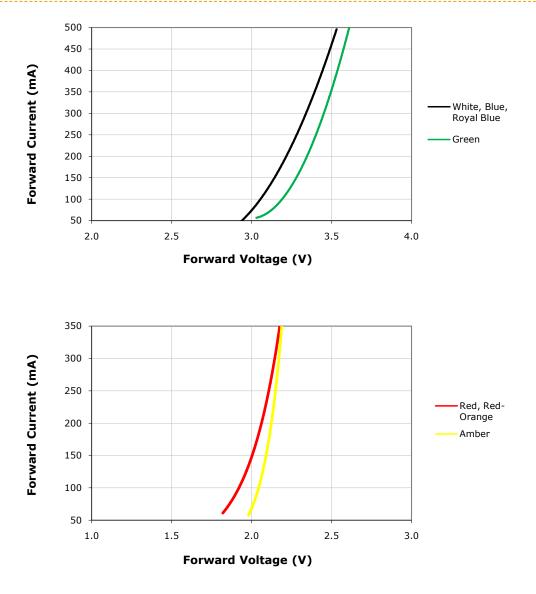
RELATIVE FLUX VS. JUNCTION TEMPERATURE (I_F = 350 mA)



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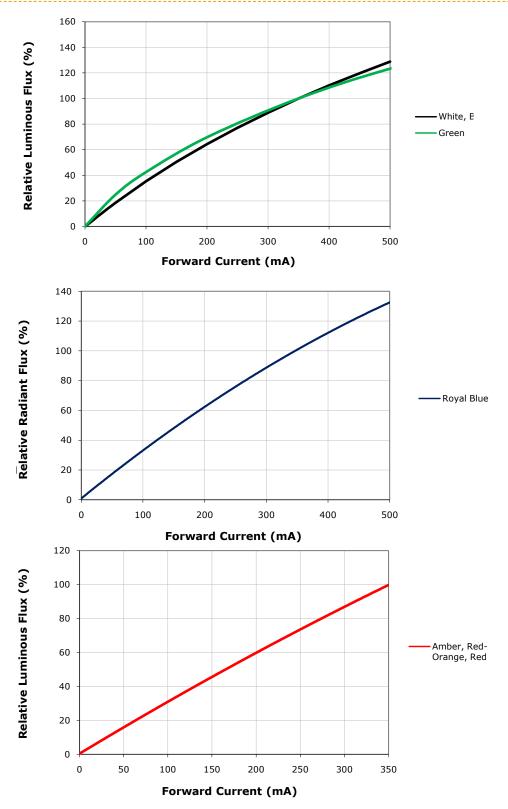


ELECTRICAL CHARACTERISTICS (T₁ = 25 °C)





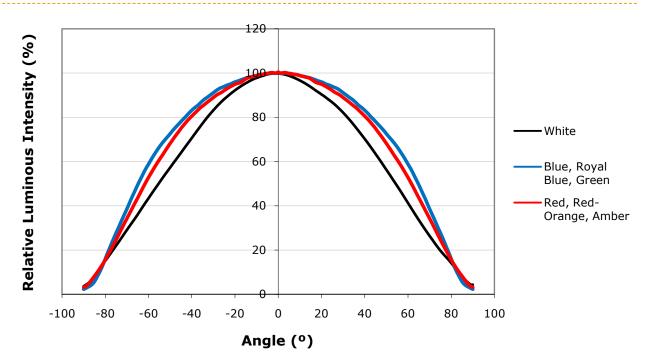
RELATIVE FLUX VS. CURRENT (T₁ = 25 °C)



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TYPICAL SPATIAL DISTRIBUTION

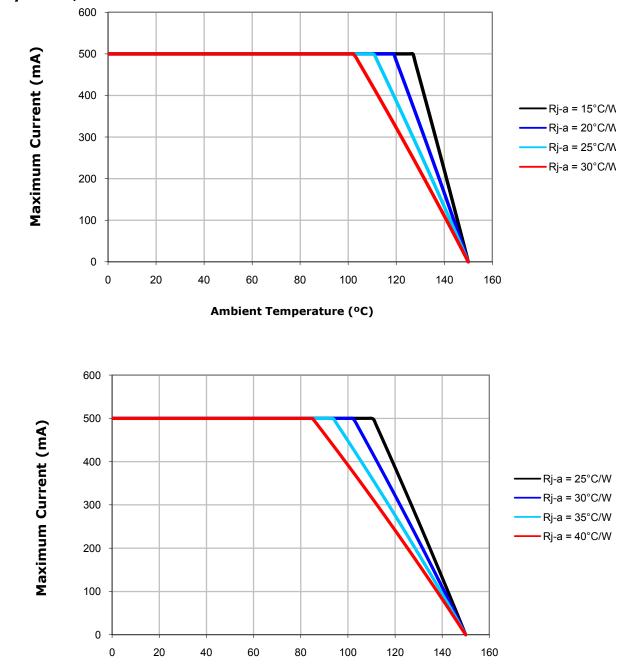




THERMAL DESIGN

Green

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



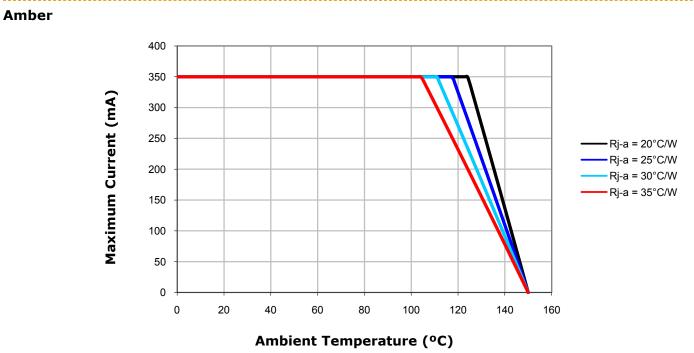
White, Royal Blue, Blue

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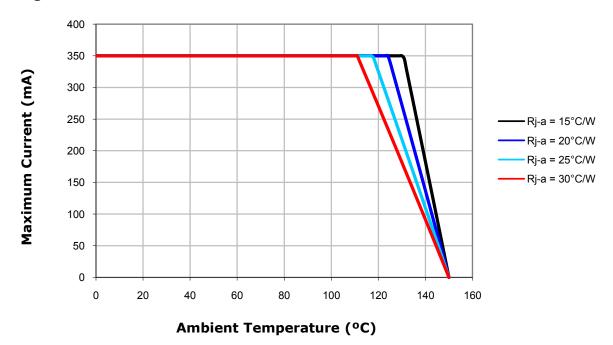
Ambient Temperature (°C)



THERMAL DESIGN (CONTINUED)



Red, Red-Orange

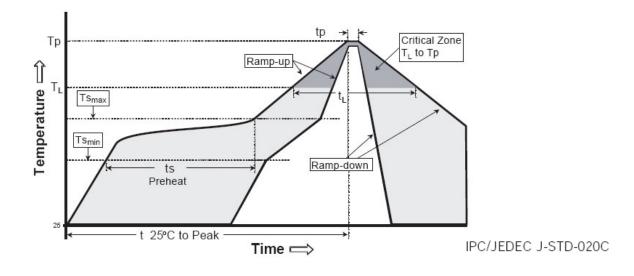




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XP-C LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts _{min})	100 °C	150 °C
Preheat: Temperature Max (Ts _{max})	150 °C	200 °C
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T_L)	183 °C	217 °C
Time Maintained Above: Time (t_L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



NOTES

Moisture Sensitivity

In testing, Cree has found XLamp XP-C & XP-E LEDs to have unlimited floor life in conditions \leq 30 °C/85% relative humidity (RH). Moisture testing included a 168-hour soak at 85 °C/85% RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

Cree recommends keeping XLamp LEDs in their sealed moisture-barrier packaging until immediately prior to use. Cree also recommends returning any unused LEDs to the resealable moisture-barrier bag and closing the bag immediately after use.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

UL Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

Vision Advisory Claim

WARNING: Do not look at exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

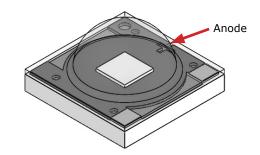
Intellectual Property

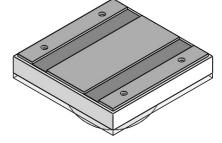
For remote phosphor applications, a separate license to certain Cree patents is required.

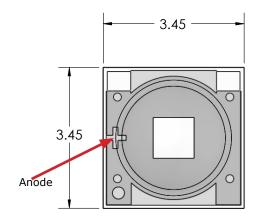


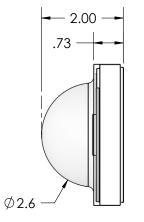
MECHANICAL DIMENSIONS ($T_A = 25^{\circ}C$)

All measurements are \pm .13 mm unless otherwise indicated.

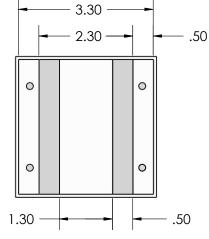




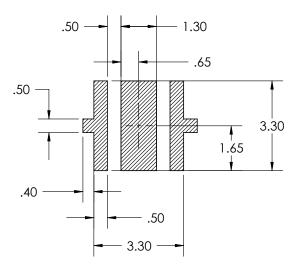




Side View

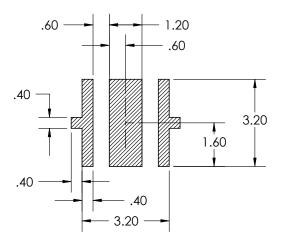


Top View



RECOMMENDED PCB SOLDER PAD

Bottom View

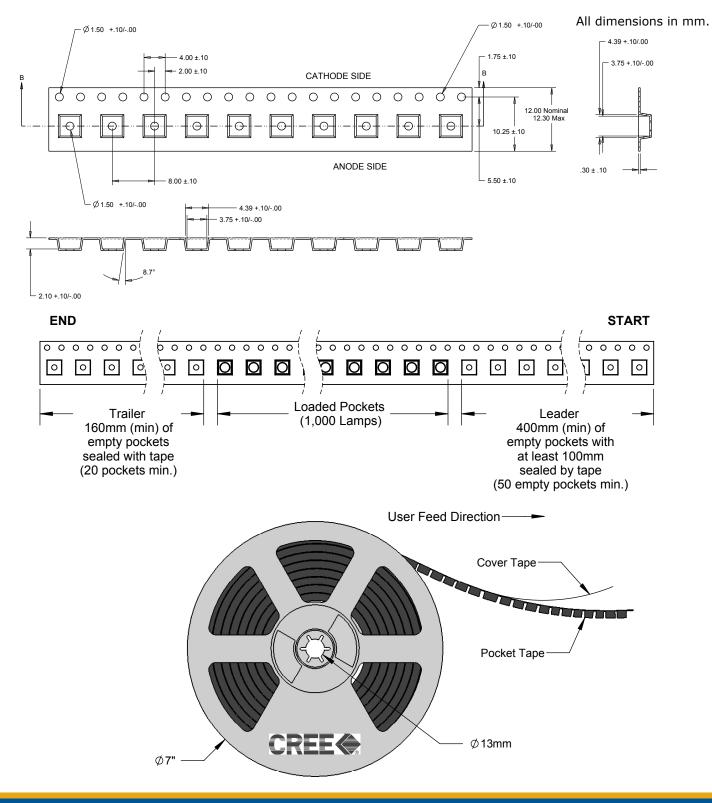


RECOMMENDED STENCIL PATTERN (HATCHED AREA IS OPENING)



TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.





PACKAGING

